

SEMICONDUCTOR TM

NDS8434A Single P-Channel Enhancement Mode Field Effect Transistor

General Description

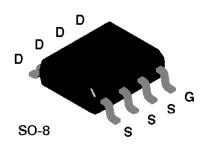
Features

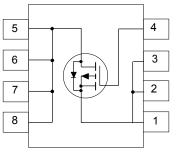
SO-8 P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

• -7.8 A, -20 V. $R_{DS(ON)} = 0.024 \Omega @ V_{GS} = -4.5 V$ $R_{DS(ON)} = 0.032 \Omega @ V_{GS} = -2.5 V.$

- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.

March 1997



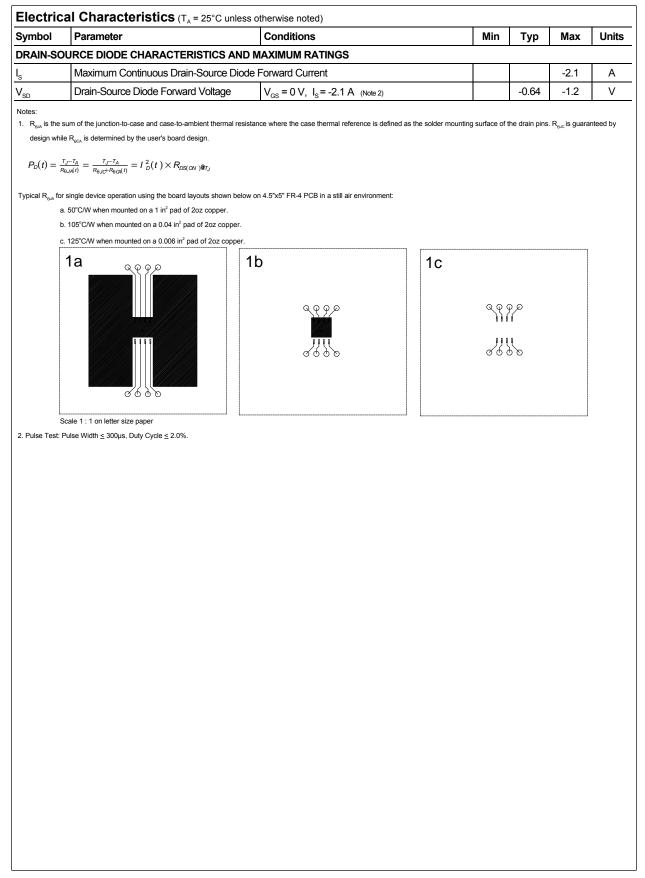


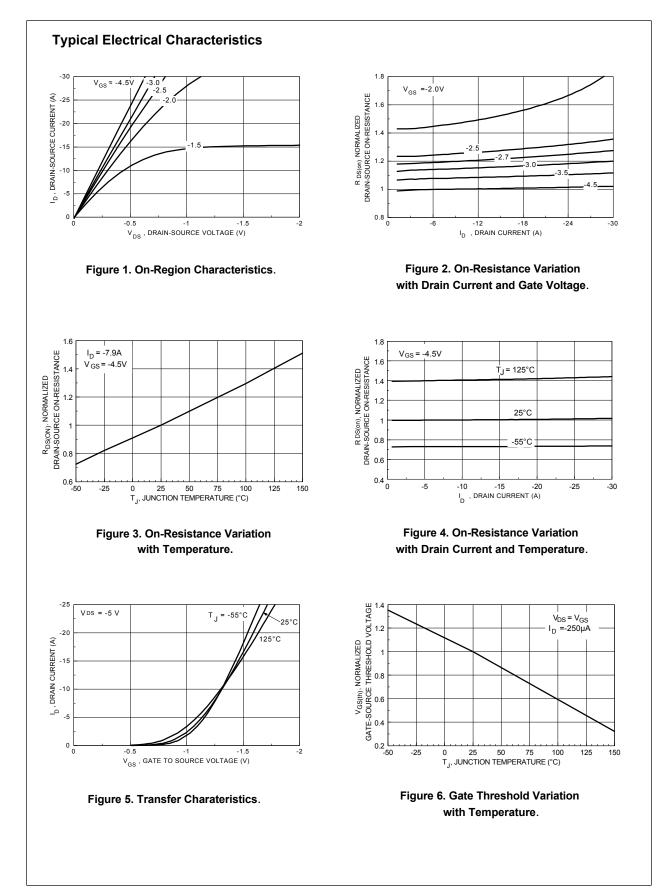
Absolute Maximum Ratings T_A = 25°C unless otherwise noted

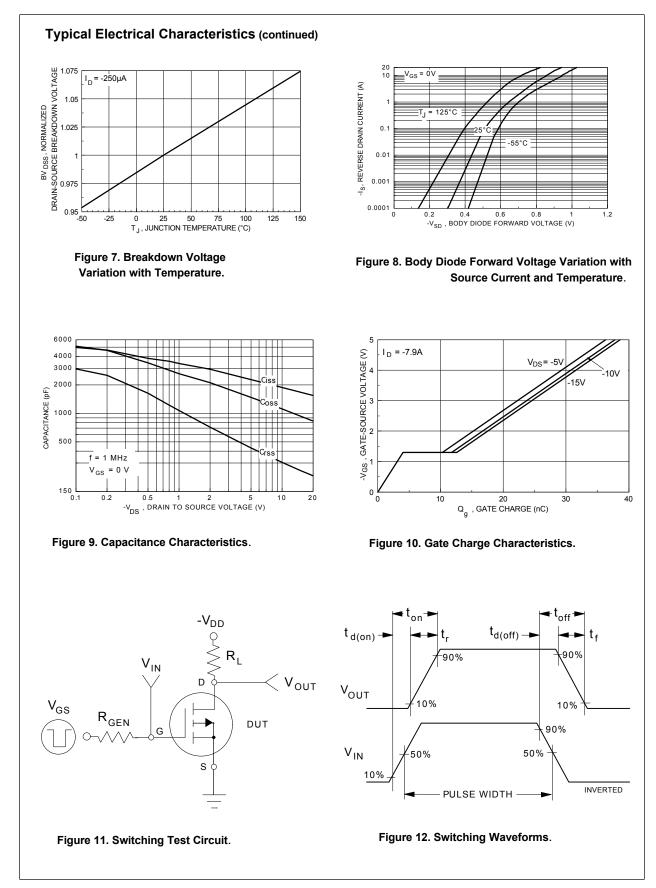
Symbol	Parameter		NDS8434A	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
I _D	Drain Current - Continuous - Pulsed	(Note 1a)	-7.8	A
			-25	
P _D	Maximum Power Dissipation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1	
Tj,T _{stg}	Operating and Storage Temperature Range		-55 to 150	°C
THERMA	L CHARACTERISTICS	-		
R _{eja}	Thermal Resistance, Junction-to-Ambient (Note 1a)		50	°C/W
R _{ejc}	Thermal Resistance, Junction-to-Case (Note 1)		25	°C/W

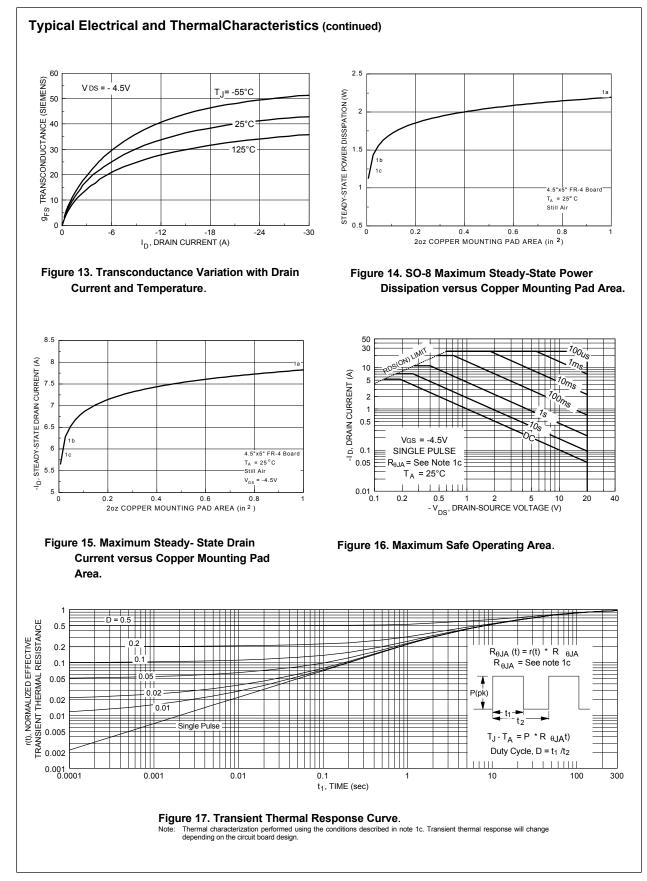
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Symbol	Parameter	Conditions		Min	Тур	Мах	Units
OFF CHA	RACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA		-20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -16 V, V _{GS} = 0 V				-1	μA
			T _J =55°C			-10	μA
I _{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$				100	nA
I _{GSSR}	Gate - Body Leakage, Reverse	V _{GS} = -8 V, V _{DS} = 0 V				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$		-0.4	-0.51	-1	V
			T _J = 125°C	-0.3	-0.32	-0.8	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = -4.5 \text{ V}, \ \text{I}_{D} = -7.9 \text{ A}$			0.021	0.024	Ω
			T _J = 125°C		0.032	0.043	
		$V_{GS} = -2.5 \text{ V}, I_{D} = -7.2 \text{ A}$			0.027	0.032	
I _{D(on)}	On-State Drain Current	$V_{GS} = -4.5 V, V_{DS} = -5 V$		-25			Α
		V_{GS} = -2.5 V, V_{DS} = -5 V		-10			
9 _{FS}	Forward Transconductance	$V_{\rm DS}$ = -4.5 V, I _D = -7.9 A			28		S
DYNAMIC	CHARACTERISTICS						
C _{iss}	Input Capacitance	$V_{\rm DS} = -10 \text{ V}, \ V_{\rm GS} = 0 \text{ V},$			1730		pF
C _{oss}	Output Capacitance	f = 1.0 MHz			1100		pF
C _{rss}	Reverse Transfer Capacitance				300		pF
SWITCHIN	IG CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	$V_{DD} = -5 V, I_{D} = -1 A,$			13	25	ns
ţ,	Turn - On Rise Time	$V_{\rm GEN}$ = -4.5 V, $R_{\rm GEN}$ = 6 Ω			38	70	ns
t _{D(off)}	Turn - Off Delay Time				210	300	ns
ţ	Turn - Off Fall Time				78	150	ns
Q _g	Total Gate Charge	$V_{DS} = -10 V,$ $I_{D} = -7.9 A, V_{GS} = -4.5 V$			35	55	nC
Q _{gs}	Gate-Source Charge				3.8		nC
Q_{gd}	Gate-Drain Charge				8.2		nC









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